

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT3475341

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TUO SHI	07/21/2015
SHIPENG YAN	07/21/2015
NAI ZHANG	07/21/2015
DONG PAN	07/21/2015
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<b>Postal Code:</b>	KY1-1104
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14807880
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	SF01.0020US
<b>NAME OF SUBMITTER:</b>	ANDY M. HAN
<b>SIGNATURE:</b>	/Andy M. Han, Reg. No. 60266/
<b>DATE SIGNED:</b>	08/07/2015
<b>Total Attachments: 4</b>	
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**COMBINED DECLARATION AND ASSIGNMENT FOR APPLICATION FOR UNITED STATES  
LETTERS PATENT  
DECLARATION**

Title of Invention: **INTEGRATED LENS-ARRAY-ON-SUBSTRATE FOR OPTICAL COUPLING SYSTEM AND FABRICATION METHOD THEREOF**

As the below named inventor, I hereby declare that:

- This declaration is directed to the attached patent application, which claims the priority benefit of U.S. Patent Application No. 61/999,317, filed on 23 July 2014.
- **The above-identified application was made or authorized to be made by me.**
- **I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.**
- **I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.**
- **I have reviewed and understand the contents of the present application, including the claims, as amended by any amendment specifically referred to herein.**
- **I acknowledge the duty to disclose to the Patent Office all information known to me to be material to patentability as defined in 37 C.F.R. § 1.56.**

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**POWER OF ATTORNEY**

As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) associated with Customer No.

13859

to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

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**Send Correspondence to:**

**Han IP Corporation  
4790 Irvine Boulevard Suite 105-347  
Irvine, CA 92620  
Direct Telephone Calls To: (949) 383-5385  
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**ASSIGNMENT**

**PARTIES TO THE ASSIGNMENT**

Assignor(s):

1. Tuo Shi
2. Shipeng Yan
3. Nai Zhang
4. Dong Pan

Assignee:

SiFotonics Technologies Co., Ltd.  
P.O. Box 309, Uglund House  
Grand Cayman, KY1-1104  
Cayman Islands

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of the above-identified invention for which:

a provisional application for United States Letters Patent was filed on

**23 July 2014** and was given U.S. Serial No. **61/999,317** and/or

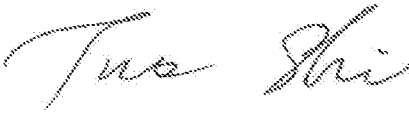
a non-provisional application for United States Letters Patent was:


filed on **23 July 2015** and was given U.S. Serial No. **14/807,880**; or filed concurrently herewith.


Assignors hereby authorize and request ASSIGNEE's legal representatives, of **Han IP Corporation, 4790 Irvine Boulevard Suite 105-347, Irvine, CA 92620**, who are associated with customer number **13859**, to handle all matters related to the above-identified application.

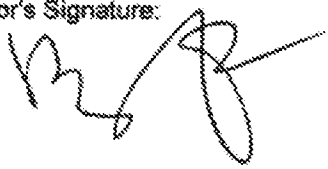
WHEREAS, SiFotonics Technologies Co., Ltd. (hereinafter referred to as ASSIGNEE), a corporation of Cayman Islands having a place of business at P.O. Box 309, Uglund House, Grand Cayman, KY1-1104, Cayman Islands, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

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<b>Legal Name of Co-Inventor: Dong Pan</b>	
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